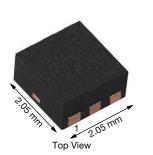
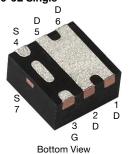
## Vishay Siliconix

# N-Channel 40 V (D-S) MOSFET

## PowerPAK® SC-70-6L Single





Marking code: A1

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	40			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0110			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.0150			
Q <sub>g</sub> typ. (nC)	5.3			
I <sub>D</sub> (A)	31 <sup>a</sup>			
Configuration	Single			

#### **FEATURES**

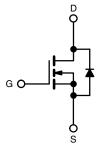
- TrenchFET® Gen IV power MOSFET
- Tuned for the lowest R<sub>DS</sub> Q<sub>oss</sub> FOM



- Thermally enhanced PowerPAK® SC-70 package - Small footprint area
- 100 % R<sub>q</sub> and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- DC/DC converters
- Synchronous rectification
- Motor drive control
- · Battery management and protection
- · Load switch



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA4446DJ-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	40	V	
Gate-source voltage		V <sub>GS</sub>	+20 / -16	v	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		31		
	T <sub>C</sub> = 70 °C	1 . —	25		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	13 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	10.6 <sup>b, c</sup>		
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	80	Α	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		17.5		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.2 <sup>b, c</sup>		
Single-pulse avalanche current	. 0.1	I <sub>AS</sub>	13		
Single-pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	8.5	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		19.2		
	T <sub>C</sub> = 70 °C		12.3	147	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.5 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C	1	2.2 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stq</sub>	-55 to +150	00	
Soldering recommendations (peak temperature) d, e			260	°C	

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient b, f	t ≤ 5 s	R <sub>thJA</sub>	28	36	°C/W		
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	5.3	6.5	- ·C/vv		

#### Notes

- a.  $T_C = 25$  °C.
- b. Surface mounted on 1" x 1" FR4 board

S23-0217-Rev. A, 17-Apr-2023

- Rework conditions: Manual soldering with a soldering iron is not recommended for leadless components
- Maximum under steady state conditions is 80 °C/W

See solder profile (<a href="https://www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

# Vishay Siliconix

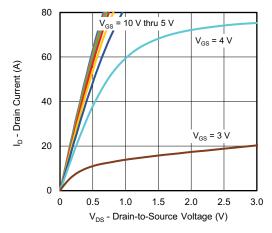
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	24	-	1.00	
V <sub>GS(th)</sub> temperature coefficient	ΔV <sub>GS(th)</sub> /T <sub>J</sub>	I <sub>D</sub> = 250 μA	-	-5	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$	1.1	-	2.4	V	
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = +20 V / -16 V	-	-	± 100	nA	
Zero gate voltage drain current		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	0 μA 110 Ω	
	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10		
	_	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	0.0086	0.0110		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 5 A	-	0.0110	0.0150		
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 20 A	-	51	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	915	_	pF	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	180	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	28	-		
C <sub>rss</sub> /C <sub>iss</sub> ratio			-	0.031	0.064		
		V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	12.6	19	nC	
Total gate charge	$Q_g$	$Q_g \qquad \qquad Q_g \qquad $	-	5.9	8		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	3	-		
Gate-drain charge	Q <sub>qd</sub>		-	1.2	-		
Output charge	Q <sub>oss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	-	6	-		
Gate resistance	$R_g$	f = 1 MHz	0.5	2.5	5.0	Ω	
Turn-on delay time	t <sub>d(on)</sub>		ı	14	30		
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_1 = 2 \Omega$	-	54	110		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	ı	14	30		
Fall time	t <sub>f</sub>		-	6	15		
Turn-on delay time	t <sub>d(on)</sub>		-	9	20	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_1 = 2 \Omega$	ı	5	10		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	16	35		
Fall time	t <sub>f</sub>	1	-	5	10		
<b>Drain-Source Body Diode Characteristic</b>							
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	17.5		
Pulse diode forward current (t = 100 μs)	I <sub>SM</sub>	-		-	60	Α	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V	-	0.85	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	15	30	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	1	-	3.1	10	nC	
Reverse recovery fall time	ta	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °\text{C}$	-	8	-		
Reverse recovery rise time	t <sub>b</sub>	1	_	7	_	ns	

### Notes

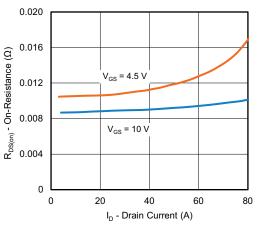
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

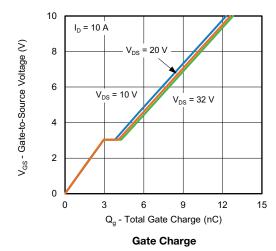


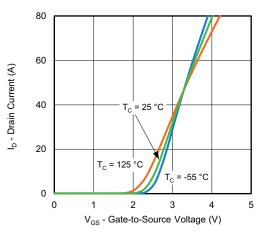


#### **Output Characteristics**

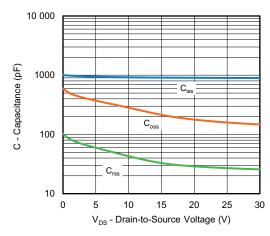


On-Resistance vs. Drain Current

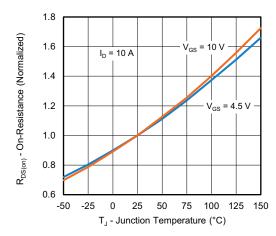




**Transfer Characteristics** 

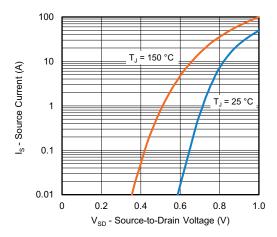


Capacitance

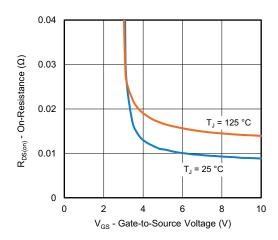


On-Resistance vs. Junction Temperature

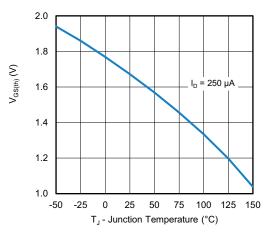




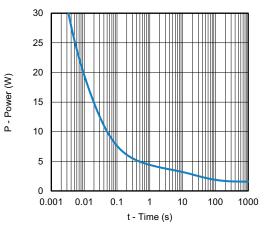
Source-Drain Diode Forward Voltage



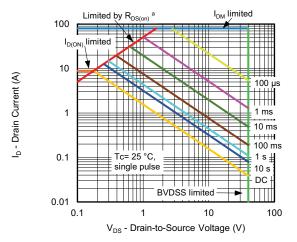
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

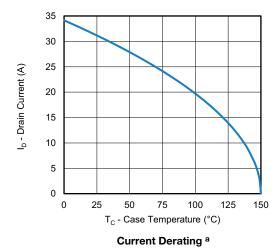


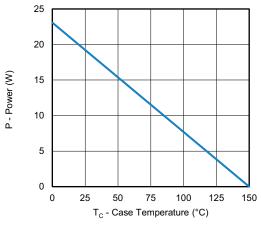
Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient



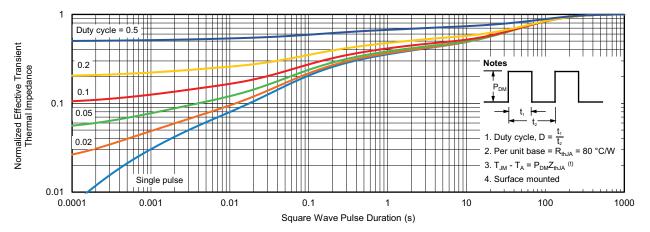




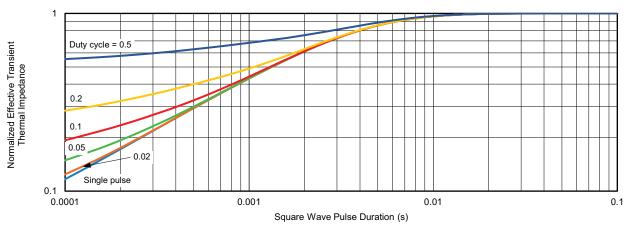
#### **Power Derating**

#### Note

a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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